

CC&C Technologies, Inc.

Scheduling Date: 2009/12/17

| Index Number  | Order Number            | component P/N | Name  | Constitute Quantity                 | Placement 1 |
|---------------|-------------------------|---------------|---|-------------------------------------|-------------|
|               |                         | Substitute    | Specification   | Base Number                         |             |
| 289G127100-11 | 0                       |               | Assembly I,EE<br>WLAN 11n Mini USB Adapter(1T2R)                | 0<br>0                              |             |
|               | 0.1 10G027110-01<br>10  |               | PCB,WLAN 11n Mini USB Adapter(1T2R,WP5<br>V 1.0,4 Level,WL-6203 | 1<br>1                              |             |
|               | 0.1 11G00000J-20<br>20  |               | Thick Film Chip Resistor<br>YAGEO,0R,J,0402                     | 2 C31,C32<br>1                      |             |
|               | 0.1 11G00000J-30<br>30  |               | Thick Film Chip Resistor<br>YAGEO,0R,J,0603                     | 2 R31,R32<br>1                      |             |
|               | 0.1 11G00102J-20<br>40  |               | Thick Film Chip Resistor<br>YAGEO,1K,J,0402                     | 2 R10,R11<br>1                      |             |
|               | 0.1 11G00103J-20<br>50  |               | Thick Film Chip Resistor<br>YAGEO,10K,J,0402                    | 1 R9<br>1                           |             |
|               | 0.1 11G00104F-20<br>60  |               | Thick Film Chip Resistor<br>YAGEO,100K,F,0402,63MW              | 1 R5<br>1                           |             |
|               | 0.1 11G00154F-20<br>70  |               | Thick Film Chip Resistor<br>YAGEO,150K,F,0402                   | 1 R7<br>1                           |             |
|               | 0.1 11G00243F-20<br>80  |               | Thick Film Chip Resistor<br>YAGEO,24K,F,0402                    | 1 R3<br>1                           |             |
|               | 0.1 11G00561J-20<br>90  |               | Thick Film Chip Resistor<br>YAGEO,560R,J,0402                   | 2 R1,R2<br>1                        |             |
|               | 0.1 11G00622J-20<br>100 |               | Thick Film Chip Resistor<br>YAGEO,6K2,J,0402                    | 1 R12<br>1                          |             |
|               | 0.1 11G00684J-20<br>110 |               | Thick Film Chip Resistor<br>YAGEO,680K,J,0402                   | 1 R6<br>1                           |             |
|               | 0.1 12G00R8C2-20<br>120 |               | Ceramic Chip Capacitor<br>TDK,0.8pF,C,0402,COG,50V              | 1 C24<br>1                          |             |
|               | 0.1 12G0100J2-20<br>130 |               | Ceramic Chip Capacitor<br>TDK,10pF,J,0402,NPO,50V               | 3 C8,C25,C26<br>1                   |             |
|               | 0.1 12G0101J2-20<br>140 |               | Ceramic Chip Capacitor<br>TDK,100pF,J,0402,COG,50V              | 1 C48<br>1                          |             |
|               | 0.1 12G0103K2-20<br>150 |               | Ceramic Chip Capacitor<br>TDK,0.01uF,K,0402,X7R,16V             | 3 C7,C39,C40<br>1                   |             |
|               | 0.1 12G0104K2-21<br>160 |               | Ceramic Chip Capacitor<br>TDK,0.1uF,K,0402,X7R,10V              | 8 C2,C6,C9,C10,C12,C14,C16,C17<br>1 |             |
|               | 0.1 12G0105K2-20<br>170 |               | Ceramic Chip Capacitor<br>TDK,1uF,K,0402,X5R,6.3V               | 6 C1,C5,C11,C13,C15,C18<br>1        |             |
|               | 0.1 12G0106K4-20<br>180 |               | Ceramic Chip Capacitor<br>TDK,10uF,K,0805,X5R,6.3V              | 1 C37<br>1                          |             |
|               | 0.1 12G01R2C2-20<br>190 |               | Ceramic Chip Capacitor<br>TDK,1.2pF,C,0402,COG,50V              | 5 C3,C4,C29,C30,R21<br>1            |             |
|               | 0.1 12G0010C2-20<br>200 |               | Ceramic Chip Capacitor<br>TDK,1pF,C,0402,COG,50V                | 1 C23<br>1                          |             |
|               | 0.1 12G0200J2-20<br>210 |               | Ceramic Chip Capacitor<br>TDK,20pF,J,0402,COG,50V               | 2 C35,C36<br>1                      |             |
|               | 0.1 12G0226Z4-20<br>220 |               | Ceramic Chip Capacitor<br>TDK,22uF,Z,0805,Y5V,6.3V              | 2 C21,C38<br>1                      |             |
|               | 0.1 12G02R2C2-20<br>230 |               | Ceramic Chip Capacitor<br>TDK,2.2pF,C,0402,COG,50V              | 3 C27,C28,R25<br>1                  |             |
|               | 0.1 12G05R6C2-20<br>240 |               | Ceramic Chip Capacitor<br>TDK,5.6pF,C,0402,COG,50V              | 1 R22<br>1                          |             |
|               | 0.1 13G0010S2-50<br>250 |               | Multi-layer Chip Inductor<br>ACX,1.0nH,S,0402                   | 2 C33,C34<br>1                      |             |
|               | 0.1 13G02R2S2-50<br>260 |               | Multi-layer Chip Inductor<br>ACX,2.2nH,S,0402                   | 2 L6,L7<br>1                        |             |
|               | 0.1 13G02R7S2-50<br>270 |               | Multi-layer Chip Inductor<br>ACX,2.7nH,S,0402                   | 5 L4,L5,L10,L11,R24<br>1            |             |

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|---------------|---------------------------|--|------------------|--|-------------|
|               | Substitute                | Specification  |                  |  |             |
| 289G127100-11 | 0.1 13G03R3S2-50<br>275   | Multi-layer Chip Inductor<br>ACX,3.3nH,S,0402                        | 1 L3<br>1        |  |             |
|               | 0.1 13G04R7S2-50<br>280   | Multi-layer Chip Inductor<br>ACX,4.7nH,S,0402                        | 1 L12<br>1       |  |             |
|               | 0.1 13G06R8J2-50<br>290   | Multi-layer Chip Inductor<br>ACX,6.8nH,J,0402                        | 2 L8,L9<br>1     |  |             |
|               | 0.1 13G8472M0-92<br>300   | SMD Inductors(Coils),4.7uH,20%<br><b>MINGSTAR</b> ,CD32N-4R7M        | 1 L33<br>1       |  |             |
|               | 0.1 13G8682M0-91<br>310   | SMD Inductors(Coils),6.8uH,20%<br><b>MINGSTAR</b> ,306-76970         | 1 L2<br>1        |  |             |
|               | 0.1 14G007103-00<br>320 * | Step-Down DC/DC Converter<br><b>Chip Advanced</b> ,CAT7103CT5,SOT25  | 1 U3<br>1        |  |             |
|               | 14G008232-00              | PWM Step-Down DC/DC Converter<br><b>iDesyn</b> ,iD8232-ADA50R,SOT-25 | 1<br>0           |  |             |
|               | 0.1 14G008191-00<br>330   | 802.11n MAC/BB Processor<br>RealTek,RTL8191SU-GR                     | 1 U1<br>1        |  |             |
|               | 0.1 18G000402-14<br>340 * | SMD Crystal,40MHz,+-10ppm<br>TXC,7M40000183,3.2*2.5mm                | 1 X1<br>1        |  |             |
|               | 18G000402-16              | SMD Crystal,40MHz,+-10ppm<br><b>Taisaw</b> ,TZ0475B,3.2*2.5mm        | 1<br>0           |  |             |
|               | 0.1 21G050300-00<br>350   | SMD 0603 Super Green LED<br><b>EPEC</b> ,0603SGC                     | 2 LED0,LED1<br>1 |  |             |
|               | 0.1 33G000001-00<br>360   | SIDE SWITCH<br><b>OBJ</b> ,DJT-1114S,SMD                             | 1 SW1<br>1       |  |             |
|               | 0.1 34G300001-01<br>370   | USB SMT Connector A type 2.0<br>CZT,USB-A1M87M-4B4N                  | 1 CON3<br>1      |  |             |
|               | 0.1 70-027101-0A<br>380   | Sche.,WLAN 11n Mini USB Adapter(1T2R)<br>V A,WL-6203                 | 0<br>1           |  |             |